

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Kenichi Kaneda	08/30/2011
RECEIVING PARTY DATA	
Name:	SUMITOMO BAKELITE CO., LTD.
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PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	13262303
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NAME OF SUBMITTER:	Eugene T. Perez
Total Attachments: 1 source=2011-09-13_Assignment_0210-0236PUS1#page1.tif	

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U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter "ASSIGNOR") by

SUMITOMO BAKELITE CO., LTD.

(Insert
ASSIGNEE's
Name(s)
Address(es))

5-8, Higashi-Shinagawa 2-chome, Shinagawa-ku, Tokyo 140-0002, Japan

(hereinafter "ASSIGNEE"), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled

(Title of
Invention)

PRINTED WIRING BOARD FABRICATION METHOD, PRINTED WIRING BOARD,

MULTILAYER PRINTED WIRING BOARD, AND SEMICONDUCTOR PACKAGE

relating to International Patent Application PCT/JP 2010 / 055401 and/or for which application for Letters Patent of the United States was executed on even date herewith or, if not so executed, was:

(Insert date
of execution
of application,
if not
concurrent)

(a) executed on August 30, 2011 ;
(b) filed on September 30, 2011 ;
Serial No. 13 / 262,303 ;

Assignee's attorney is hereby authorized to insert in (b) the specified data, when known.

and to said application and all Letters Patent(s) of the United States granted on said application and any continuation, division, renewal, substitute, reissue or reexamination application based thereon, for the full term or terms for which the said Letters Patent(s) may be granted and including any extensions thereof (collectively, hereinafter, "said application(s) and Letters Patent(s)").

The ASSIGNOR agree(s), when requested by said ASSIGNEE and without charge to but at the expense of said ASSIGNEE, to do all acts which the ASSIGNEE may deem necessary, desirable or expedient, for securing, maintaining and enforcing protection for said invention, including in the preparation and prosecution of said application(s) and the issuance of said Letters Patent(s), in any interference, reissue, reexamination, or public use proceeding, and in any litigation or other legal proceeding which may arise or be declared in relation to same, such acts to include but not be limited to executing all papers, including separate assignments and declarations, taking all rightful oaths, providing sworn testimony, and obtaining and producing evidence.

IN WITNESS WHEREOF, the undersigned inventor(s) has (have) affixed his/her/their signature(s).

(Signatures)

1) <u>Kenichi Kaneda</u> (SIGNATURE)	<u>Kenichi Kaneda</u> (TYPE NAME)	<u>August 30, 2011</u> (DATE)
2) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
3) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
4) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
5) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
6) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
7) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)
8) _____ (SIGNATURE)	_____ (TYPE NAME)	_____ (DATE)

PATENT